

SOT-23 Plastic-Encapsulate MOSFETS

Features

- $V_{DS} = -100V$
- $I_D = -1A$
- $R_{DS(on)}@V_{GS} = -10V < 650m\Omega$
- $R_{DS(on)}@V_{GS} = -6V < 700m\Omega$
- Improved dv/dt capability
- Advanced Trench Technology
- Fast switching speed

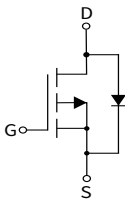
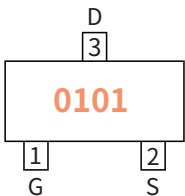
Applications

- Load Switch
- PWM Application
- Power Mangement

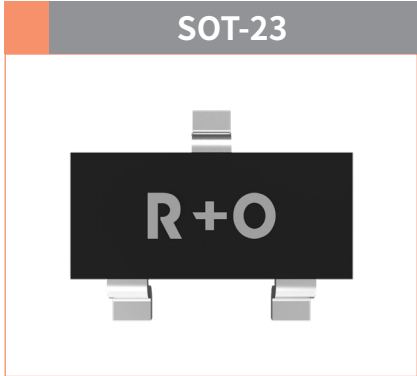
Mechanical Data

- Case: SOT-23
Molding compound meets UL 94V-0 flammability rating, RoHS-compliant,halogen-free
- Terminals: Solder plated, solderable per MIL-STD-750,Method 2026

Function Diagram



Drain-source Voltage
-100 V
Drain Current
-1 Ampere



Ordering Information

PACKAGE	PACKAGE CODE	UNIT WEIGHT(g)	REEL(pcs)	BOX(pcs)	CARTON(pcs)	DELIVERY MODE
SOT-23	R1	0.008	3000	30000	180000	7"

Maximum Ratings (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	UNIT	VALUE
Drain-source Voltage	V_{DS}	V	-100
Gate-source Voltage	V_{GS}	V	± 20
Drain Current	I_D	A	-1
Pulsed Drain Current	I_{DM}	A	-1.5
Total Power Dissipation	P_D	W	0.5
Thermal Resistance Junction-to-Ambient @ Steady State	$R_{\theta JA}$	$^{\circ}C / W$	250
Junction and Storage Temperature Range	T_J, T_{STG}	$^{\circ}C$	-55 ~+150

● Static Parameter Characteristics (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	Condition	UNIT	Min	Typ	Max
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=-250\mu A$	V	-100	—	—
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=-100V, V_{GS}=0V$	μA	—	—	-1.0
Gate-Body Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	nA	—	—	± 100
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=-250\mu A$	V	-1.0	-2.0	-2.5
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=-10V, I_D=-1A$	m Ω	—	475	650
		$V_{GS}=-6V, I_D=-0.5A$		—	496	700

● Dynamic Parameters (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	Condition	UNIT	Min	Typ	Max
Input Capacitance	C_{iss}	$V_{DS}=0V$ $V_{GS}=-50V$ $f=1MHz$	pF	—	447	—
Output Capacitance	C_{oss}			—	36	—
Reverse Transfer Capacitance	C_{rss}			—	25	—

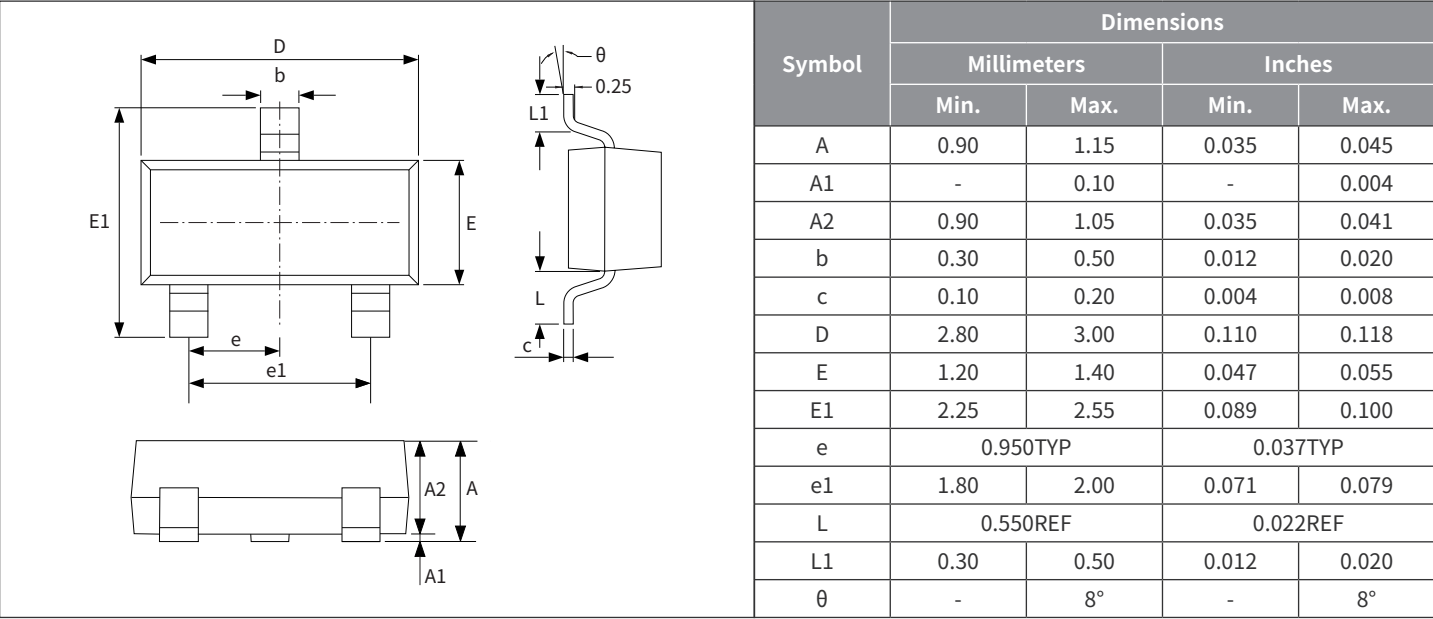
● Switching Parameters (Ta=25°C Unless otherwise specified)

PARAMETER	SYMBOL	Condition	UNIT	Min	Typ	Max
Total Gate Charge	Q_g	$V_{GS}=-10V$ $V_{DS}=-50V$ $I_D=-1A$	nC	—	3.3	—
Gate-Source Charge	Q_{gs}			—	0.47	—
Gate-Drain Charge	Q_{gd}			—	1.45	—
Turn-on Delay Time	$t_{D(on)}$	$V_{GS}=-10V$ $V_{DS}=-50V$ $I_D=-1A$ $R_{GEN}=6\Omega$	nS	—	7	—
Turn-on Rise Time	t_r			—	11	—
Turn-off Delay Time	$t_{D(off)}$			—	9	—
Turn-off fall Time	t_f			—	10	—

● Drian-Source Diode Characteristics

PARAMETER	SYMBOL	Condition	UNIT	Min	Typ	Max
Diode Forward Voltage	V_{SD}	$I_S=-1A, V_{GS}=0V$	V	—	—	-1.3
Maximum Body-Diode Continuous Current	I_S	—	A	—	—	-1

● Package Outline Dimensions (SOT-23)



● Suggested Pad Layout

